



SURFACE MOUNT SWITCHING DIODE ARRAY

Features

- · Fast Switching Speed
- Low Forward Voltage: Maximum of 0.715V at 1mA
- · Fast Reverse Recovery: Maximum of 4ns
- Low Capacitance: Maximum of 1.5pF
- Low Leakage Current
- Ultra-Small Surface Mount Package
- Thermally Efficient Copper Alloy Leadframe for High Power Dissipation
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen- and Antimony-Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Case: SOT563
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Copper Alloy Lead-Frame (Lead Free Plating). Solderable per MIL-STD-202, Method 208 (§3)
- Weight: 0.003 grams (Approximate)

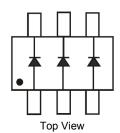








Bottom View



Ordering Information (Note 4)

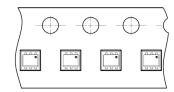
Part Number	Compliance	Case	Packaging
BAS16VA-7	Standard	SOT563	3,000/Tape & Reel

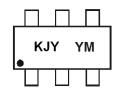
Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3).compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

Special taping orientation requirement, see below image for details.





KJY = Product Type Marking Code YM = Date Code Marking Y = Year (ex: H = 2020) M = Month (ex: 9 = September)

Date Code Key

Year	2018	3	2019		2020	20	21	2022		2023		2024
Code	F		G		Н			J		K		L
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@ T_A = 25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage	V_{RM}	100	V	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	100	V	
RMS Reverse Voltage		$V_{R(RMS)}$	71	V
Forward Continuous Current (Note 5)	I _{FM}	200	mA	
Non-Repetitive Peak Forward Surge Current @ t = 1.0µs @ t = 1.0ms @ t = 1.0s		I _{FSM}	4.0 1.0 0.5	А

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P_{D}	350	mW
Thermal Resistance Junction to Ambient Air (Note 5)	$R_{ hetaJA}$	357	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

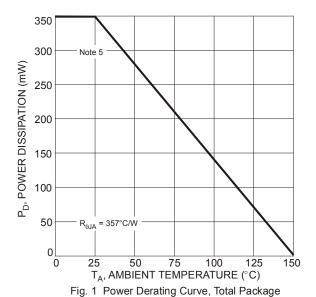
Electrical Characteristics (@ T_A = 25°C, unless otherwise specified.)

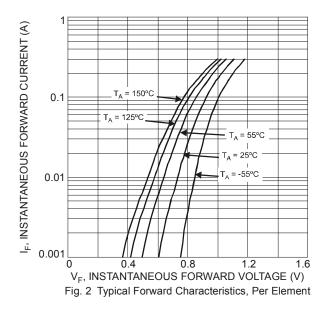
Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	V _{(BR)R}	100	_	V	I _R = 100μA
	VF		0.715	V	I _F = 1.0mA
Forward Voltage			0.855		I _F = 10mA
Forward Vollage			1.0		I _F = 50mA
			1.25		I _F = 150mA
	I _R		0.5	μA	V _R = 80V
Leakage Current (Note 6)			50	μA	V _R = 80V, T _J = 125°C
Leakage Current (Note o)			30	μA	V _R = 25V, T _J = 125°C
		_	30	nA	V _R = 25V
Total Capacitance		_	1.5	pF	V _R = 0, f = 1.0MHz
Reverse Recovery Time			4.0	ns	$I_F = I_R = 10 \text{mA},$ $I_{rr} = 0.1 \text{ x } I_R, R_L = 100 \Omega$

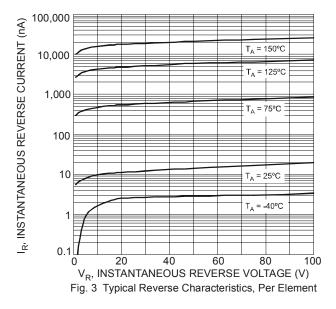
Notes:

- 5. Device mounted on FR-4 PCB, on minimum recommended 2oz copper pad layout.6. Short duration pulse test used to minimize self-heating effect.









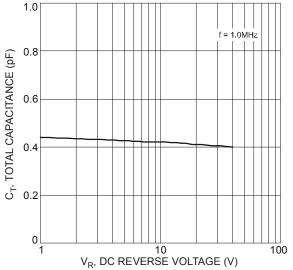


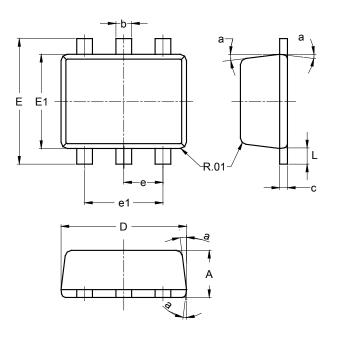
Fig. 4 Total Capacitance vs. Reverse Voltage, Per Element



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT563

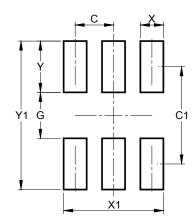


SOT563							
Dim	Min	Max	Тур				
Α	0.55	0.60	0.60				
b	0.15	0.30	0.20				
С	0.10	0.18	0.11				
D	1.50	1.70	1.60				
Е	1.55	1.70	1.60				
E1	1.10	1.25	1.20				
е			0.50				
e1	0.90	1.10	1.00				
L	0.10	0.30	0.20				
а	8°	9°	7°				
All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT563



Dimensions	Value (in mm)
С	0.500
C1	1.270
G	0.600
Х	0.300
X1	1.300
Y	0.670
V1	1 940



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